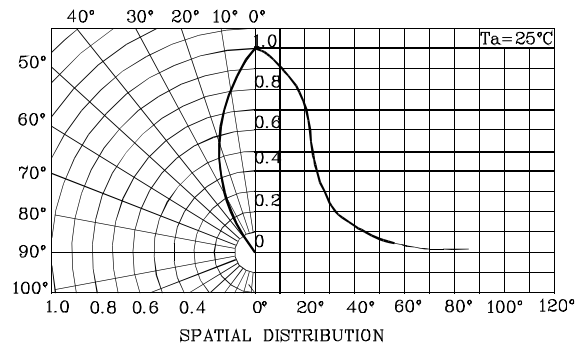
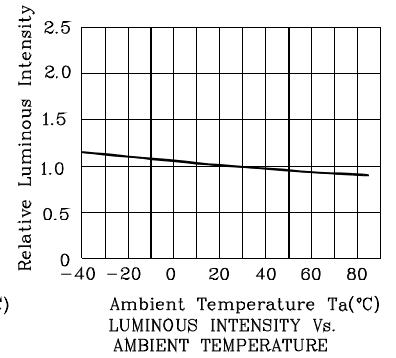
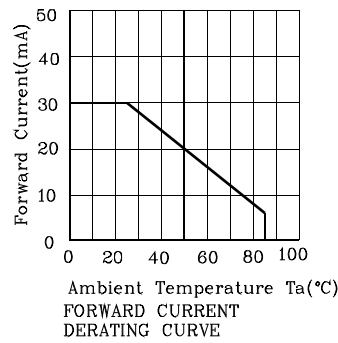
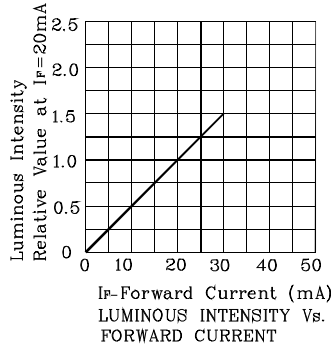
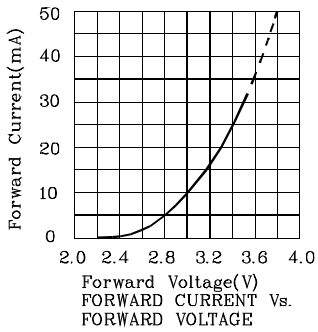
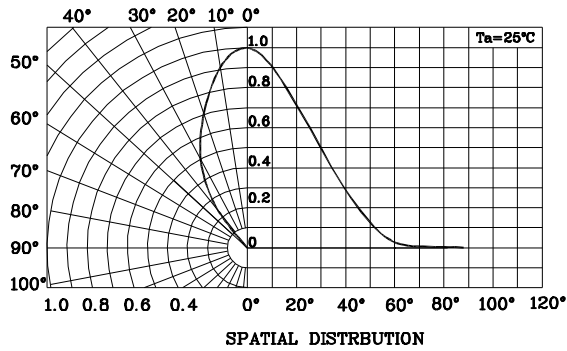
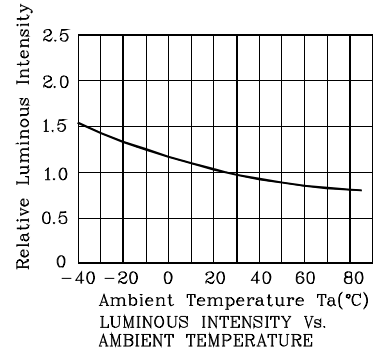
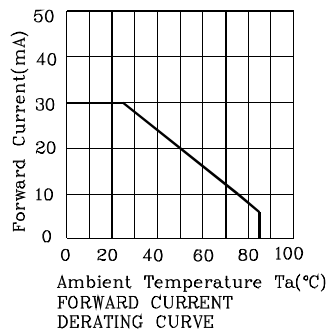
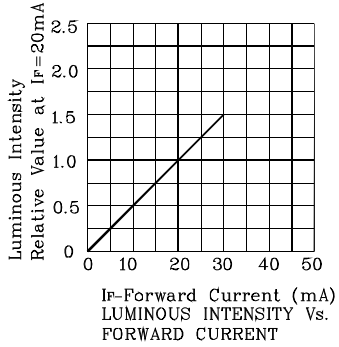
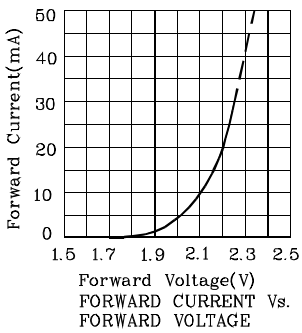


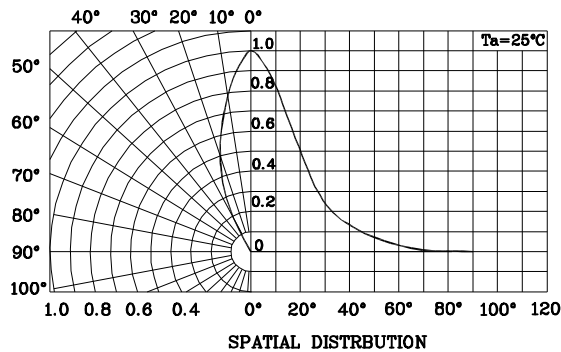
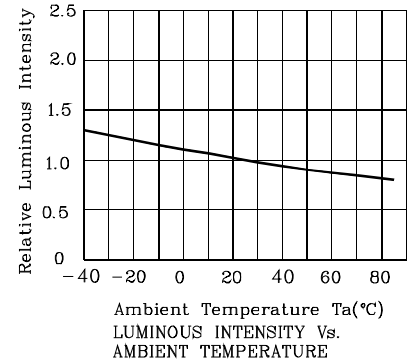
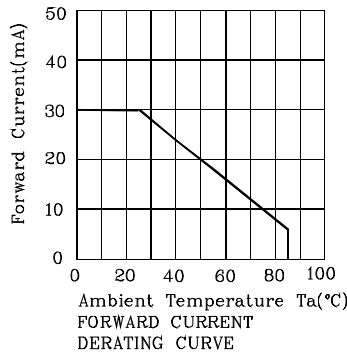
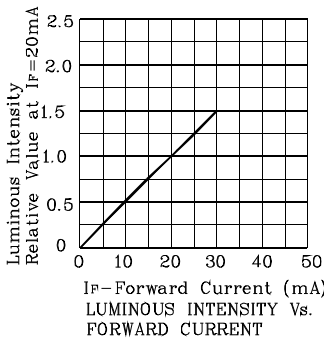
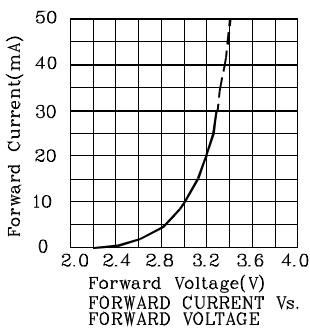
❖ FBB



❖ M2ACR



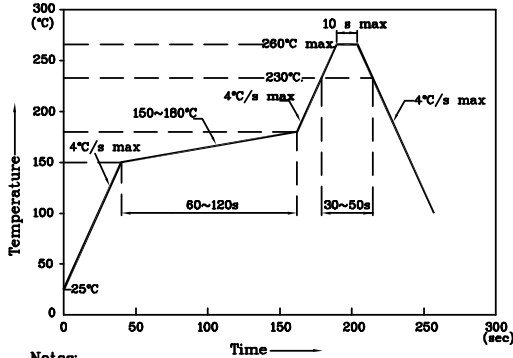
❖ M2DG



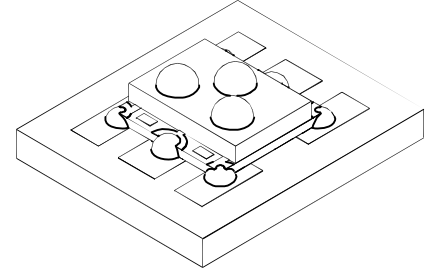
LED is recommended for reflow soldering and soldering profile is shown below.

❖ The device has a single mounting surface. The device must be mounted according to the specifications.

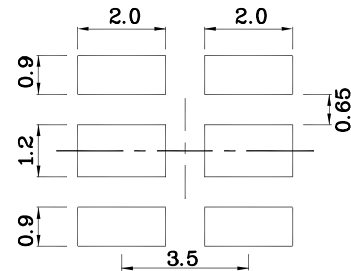
Reflow Soldering Profile for SMD Products (Pb-Free Components)



- Notes:
1. Maximum soldering temperature should not exceed 260°C
  2. Recommended reflow temperature: 145°C-260°C
  3. Do not put stress to the epoxy resin during high temperatures conditions

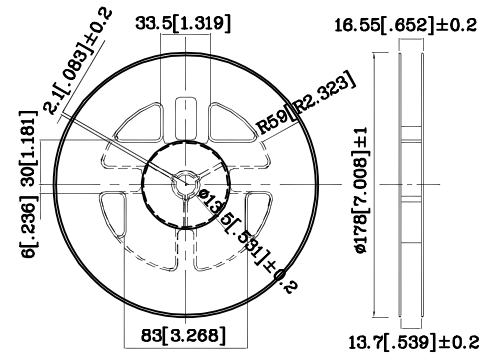
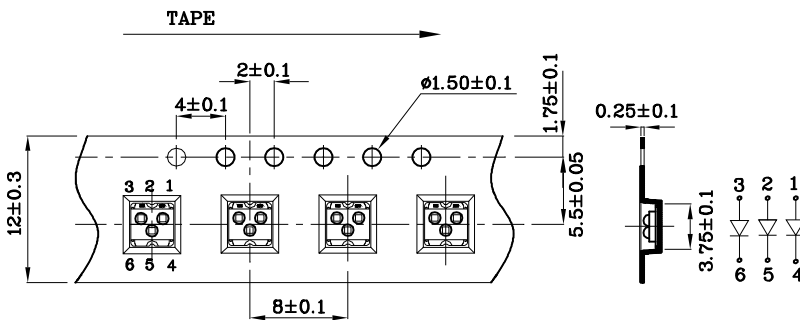


❖ Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



❖ Tape Specification (Units : mm)

❖ Reel Dimension



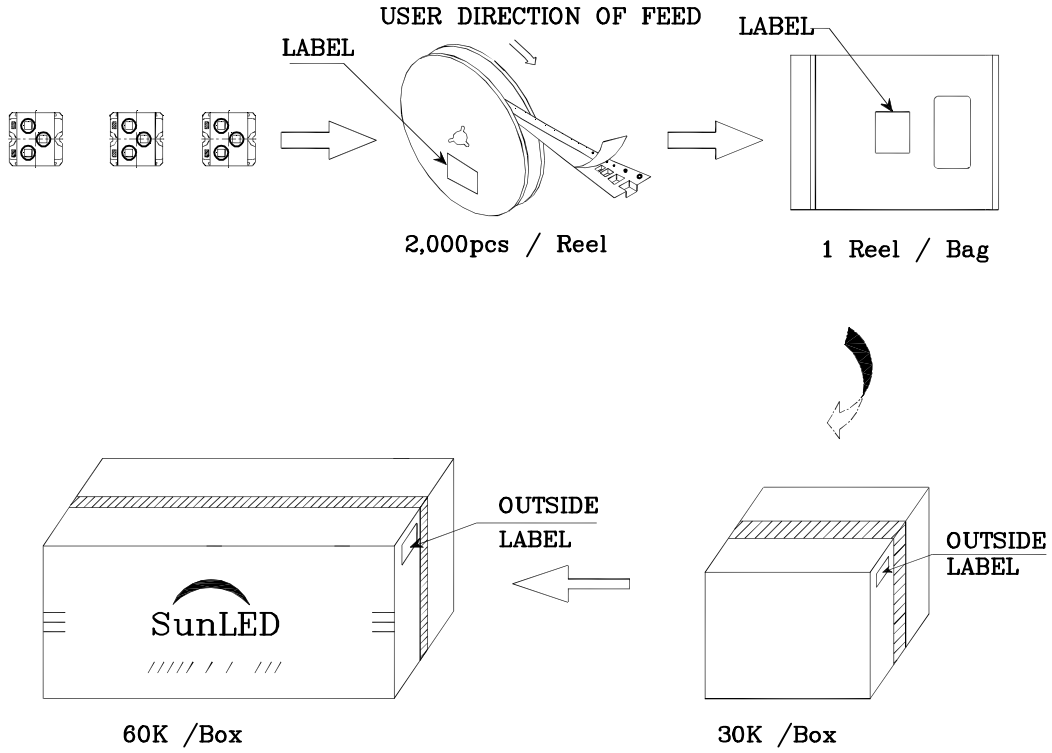

Remarks:


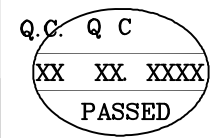

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous intensity / luminous flux: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

**PACKING & LABEL SPECIFICATIONS**

		
P/NO : XZxxx92x-3		
QTY : 2,000pcs	CODE: XXX	
S/N : XX		
LOT NO:		
 xxxxxxxxxxxxxxxxxxxxxxxx		
RoHS Compliant		